

Notice of References Cited	Application/Control No. 10/671,334		Applicant(s)/Patent Under Reexamination HUANG ET AL.	
	Examiner Alexander O. Williams		Art Unit 2826	Page 1 of 1

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	C	US-5,220,200	06-1993	Blanton, James A.	257/778
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NON-PATENT DOCUMENTS

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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.